

## **PNP Current Driver Transistor**

## **NZT753**

This device is designed for power amplifier, regulator and switching circuits where speed is important. Sourced from Process 5P.

#### **ABSOLUTE MAXIMUM RATINGS**

(T<sub>A</sub> = 25°C unless otherwise noted.) (Notes 1, 2)

Symbol	Parameter	Value	Unit
V <sub>CEO</sub>	Collector-Emitter Voltage	-100	V
V <sub>CBO</sub>	Collector-Base Voltage	-120	V
V <sub>EBO</sub>	Emitter-Base Voltage	-5.0	V
I <sub>C</sub>	Collector Current - Continuous	-4.0	Α
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. These ratings are based on a maximum junction temperature of 150°C.
- These are steady limits. The factory should be consulted on application involving pulsed or low duty cycle operations.

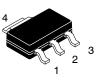
#### THERMAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted.})$  (Note 3)

Symbol	Parameter	Max	Unit
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	1.2 9.7	W mW/°C
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	103	°C/W

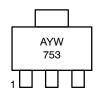
3. Device mounted on FR-4PCB 36 mm  $\times$  18 mm  $\times$  1.5 mm; mounting pad for the collector lead min. 6 cm<sup>2</sup>.

# Base Collector Emitter



SOT-223 CASE 318H

#### **MARKING DIAGRAM**



A = Assembly Location

Y = Year W = Work Week

753 = Specific Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NZT753	SOT-223 (Pb-Free)	4,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted.) (Note 4)

Symbol	Parameter	Test Conditions	Min	Max	Unit
OFF CHARACTERISTICS					
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	$I_C = -10 \text{ mA}, I_B = 0$	-100	-	V
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	$I_C = -100 \mu A, I_E = 0$	-120	-	V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = -100 \mu\text{A},  I_C = 0$	-5.0	-	V
I <sub>CBO</sub>	Collector-Base Cutoff Current	$V_{CB} = -100 \text{ V}, I_E = 0$ $V_{CB} = -100 \text{ V}, I_E = 0, T_A = 100^{\circ}\text{C}$	_ _	-0.1 -10	μ <b>Α</b> μ <b>Α</b>
I <sub>EBO</sub>	Emitter-Base Cutoff Current	$V_{EB} = -4 \text{ V}, I_{C} = 0$	-	-0.1	μΑ
ON CHARACTERISTICS (Note 4)					
h <sub>FE</sub>	DC Current Gain	$V_{CE} = -2.0 \text{ V}, I_{C} = -50 \text{ mA}$ $V_{CE} = -2.0 \text{ V}, I_{C} = -500 \text{ mA}$ $V_{CE} = -2.0 \text{ V}, I_{C} = -1.0 \text{ A}$	70 100 55	300 -	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> = -1.0 A, I <sub>C</sub> = -50 mA		-0.3	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	I <sub>C</sub> = -1.0 A, I <sub>B</sub> = -100 mA		-1.25	V

#### **NZT753**

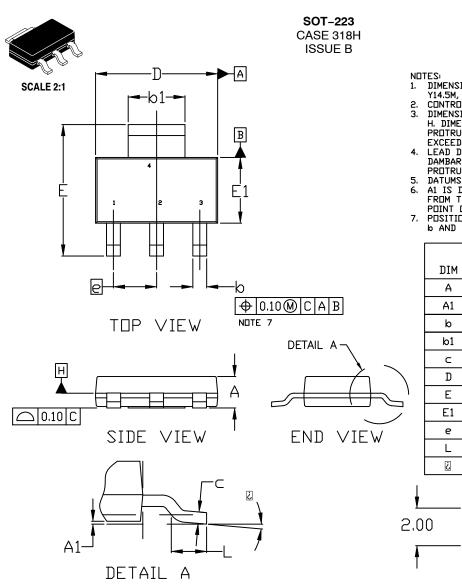
## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted.) (Note 4) (continued)

	,	, , , , , , , , , , , , , , , , , , , ,				
Symbol	Parameter	Test Conditions	Min	Max	Unit	
ON CHARA	ON CHARACTERISTICS (Note 4)					
V <sub>BE</sub> (on)	Base-Emitter On Voltage	$V_{CE} = -2.0 \text{ V}, I_{C} = -1.0 \text{ A}$	-	-1.0	V	
SMALL SIGNAL CHARACTERISTICS						
f <sub>T</sub>	Transition Frequency	$V_{CE} = -5 \text{ V}, I_{C} = -100 \text{ mA}, f = 100 \text{ MHz}$	75	-	MHz	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2.0%.



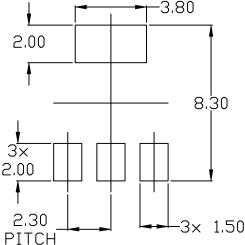


**DATE 13 MAY 2020** 

- DIMENSIONING AND TOLERANCING PER ASME
- DIMENSIDNING AND TOLERANCING PER ASME Y14.5M, 2009.
  CONTROLLING DIMENSION: MILLIMETERS DIMENSIONS D & E1 ARE DETERMINED AT DATUM H. DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSIONS DR GATE BURRS. SHALL NOT EXCEED 0.23mm PER SIDE.
  LEAD DIMENSIONS & AND &1 DO NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBBAR PROTRUSION. ALLOWABLE DAMBBAR PROTRUSION IS 0.08mm PER SIDE.
  DATUMS A AND B ARE DETERMINED AT DATUM H. A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.
  POSITIONAL TOLERANCE APPLIES TO DIMENSIONS & AND &1.

- b AND b1.

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α			1.80	
A1	0.02	0.06	0.11	
b	0.60	0.74	0.88	
b1	2.90	3.00	3.10	
С	0.24		0.35	
D	6.30	6.50	6.70	
E	6.70	7.00	7.30	
E1	3.30	3.50	3.70	
е	2.30 BSC			
L	0.25			
Ŀ	0*		10°	



#### = Pb-Free Package **AYW** (Note: Microdot may be in either location) XXXXX.

Υ

W

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

= Year

= Work Week XXXXX = Specific Device Code

= Assembly Location

## RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the IIN Semiconductor Soldering and Mounting Techniques Reference Manual, SILDERRM/D.

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DESCRIPTION:	SOT-223		PAGE 1 OF 1	

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**GENERIC** 

**MARKING DIAGRAM\*** 

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